



NOTES:
 - R16 for test purposes only
 - REFDES > 100 added to board

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Orderable:	Designed for: Public Release	Mod. Date: 8/7/2023
TID #: N/A	Project Title: 3 phase input non-isolated high-side inv buckboost	
Number: PMP31253	Rev: B	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:	File: PMP31253 RevB.SchDoc	Size: B
Engineer: F. Mueller	Contact: http://www.ti.com/support	



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